

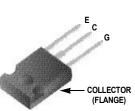
FGH40T100SMD 1000V, 40A Field Stop Trench IGBT

Features

- · High current capability
- Low saturation voltage: V_{CE(sat)} = 1.9V(Typ.) @ I_C = 40A •
- High input impedance •
- Fast switching
- RoHS compliant •

Applications

- UPS, welder, solar application
- PFC application





Absolute Maximum Ratings

Symbol	Description		Ratings	Units
V _{CES}	Collector to Emitter Voltage		1000	V
V _{GES}	Gate to Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	80	A
·C	Collector Current	@ T _C = 125°C	40	A
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	120	А
I _F	Diode Forward Current	@ T _C = 25°C	80	A
	Diode Forward Current	@ T _C = 125°C	40	A
I _{FM (1)}	Pulsed Diode Forward Current	@ T _C = 25°C	120	A
P _D	Maximum Power Dissipation	@ T _C = 25°C	333	W
	Maximum Power Dissipation	@ T _C = 125°C	111	W
Tj	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes: 1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.45	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	0.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

General Description

Using Novel Field Stop Trench IGBT Technology, Fairchild's new series of Field Stop Trench IGBTs offer the optimum performance for hard switching application such as UPS, welder, solar applications.



Package Marking and Ordering Information

Device Marking	Device	Package	⊘ico Status	Packaging Type	Qty per Tube
FGH40T100SMD	FGH40T100SMD	TO-247	RoHS	Tube	30ea

For Fairchild's definition of "green" Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

Electrical Characteristics of the IGBT $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0V, I _C = 1mA	1000	-	-	V
$\frac{\Delta \text{BV}_{\text{CES}}}{\Delta \text{T}_{\text{J}}}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 250 uA	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	1000	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±500	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I_{C} = 250uA, V_{CE} = V_{GE}	4.2	5.3	6.5	V
		I _C = 40A, V _{GE} = 15V	-	1.9	2.3	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 125^{\circ}C$	-	2.3	-	V
Dynamic C	characteristics					
Cies	Input Capacitance		-	3980	5295	pF
C _{oes}	Output Capacitance	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz	-	124	165	pF
C _{res}	Reverse Transfer Capacitance		-	76	115	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	29	38	ns
t _r	Rise Time		-	42	55	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 600V, I _C = 40A,	-	285	371	ns
t _f	Fall Time	$R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$	-	23	30	ns
Eon	Turn-On Switching Loss		-	2.35	3.1	mJ
E _{off}	Turn-Off Switching Loss		-	1.15	1.5	mJ
E _{ts}	Total Switching Loss		-	3.5	4.6	mJ
t _{d(on)}	Turn-On Delay Time		-	27	36	ns
t _r	Rise Time		-	49	64	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 600V, I _C = 40A,	-	285	371	ns
		R _G = 10Ω, V _{GE} = 15V,	_	20	26	ns
t _f	Fall Time		-		20	-
	Fall Time Turn-On Switching Loss	Inductive Load, $T_C = 175^{\circ}C$	-	4.4	5.7	mJ
			-			mJ mJ
Eon	Turn-On Switching Loss		-	4.4	5.7	
E _{on} E _{off}	Turn-On Switching Loss Turn-Off Switching Loss	- Inductive Load, T _C = 175°C - -	-	4.4 1.9	5.7 2.5	mJ
E _{on} E _{off} E _{ts}	Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss		- - - - -	4.4 1.9 6.3	5.7 2.5 8.2	mJ mJ

Symbol	Parameter	Test Condition	ns	Min.	Тур.	Мах	Unit s
V _{FM}	Diode Forward Voltage	I _F = 40A	T _C = 25°C	-	3.4	4.4	V
Plote Forward Voltage	IF FOR	T _C = 175°C	-	2.6	-		
E _{rr}	Diode Reverse Recovery Energy	I _F =40A, dI _F /dt = 200A/μs	T _C = 175°C	-	100	130	uJ
t _{rr}	Diode Reverse Recovery Time	I _F =40A, dI _F /dt = 200A/μs	T _C = 25°C	-	60	78	ns
٩r			T _C = 175 ^o C	-	256	-	
Q _{rr}	rr Diode Reverse Recovery Charge		T _C = 25°C	-	185	260	nC
∝n	Blode Reference Receivery enalge		T _C = 175 ^o C	-	1512	-	

Electrical Characteristics of Diode $T_C = 25^{\circ}C$ unless otherwise noted

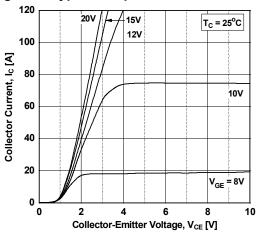


Figure 1. Typical Output Characteristics

Figure 3. Typical Saturation Voltage Characteristics

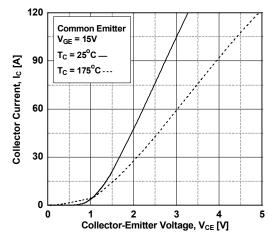


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

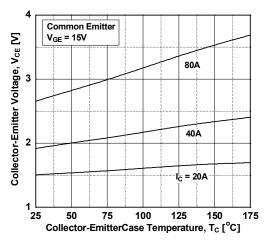


Figure 2. Typical Output Characteristics

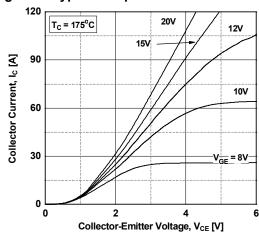


Figure 4. Transfer Characteristics

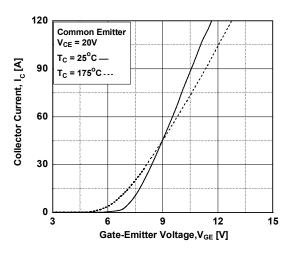


Figure 6. Saturation Voltage vs. V_{GE}

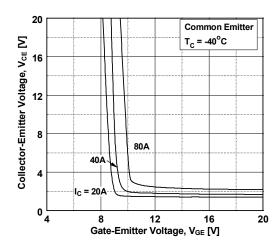


Figure 7. Saturation Voltage vs. V_{GE}

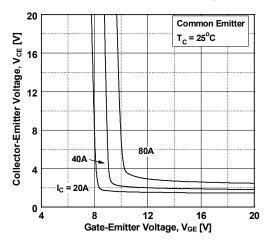


Figure 9. Capacitance Characteristics

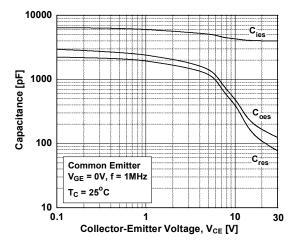


Figure 11. SOA Characteristics

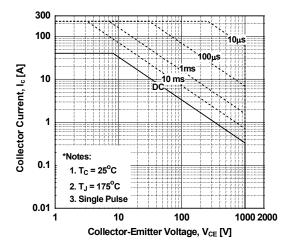


Figure 8. Saturation Voltage vs. V_{GE}

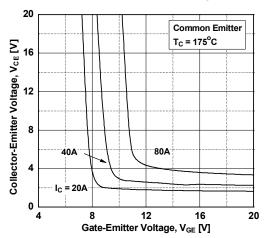


Figure 10. Gate charge Characteristics

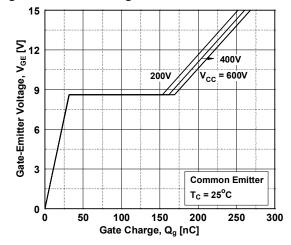
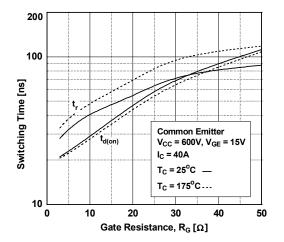


Figure 12. Turn-on Characteristics vs. Gate Resistance



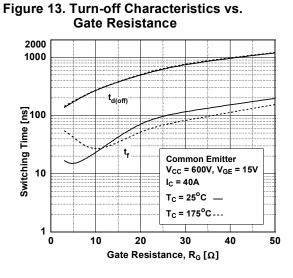


Figure 15. Turn-off Characteristics vs. Collector Current

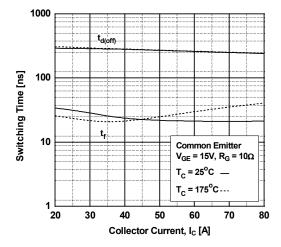
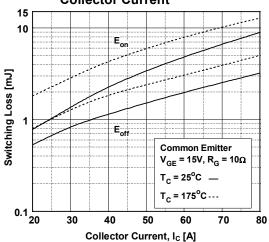


Figure 17. Switching Loss vs. Collector Current



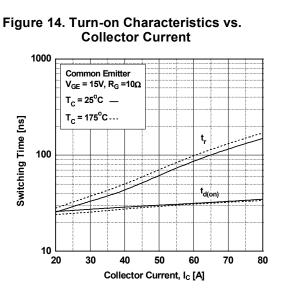


Figure 16. Switching Loss vs. Gate Resistance

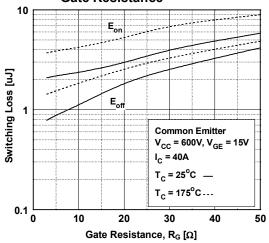
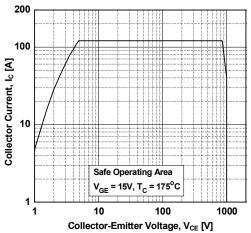
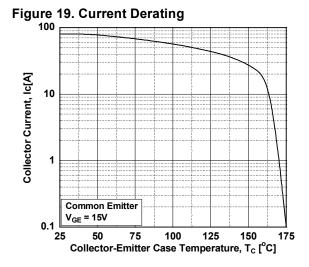
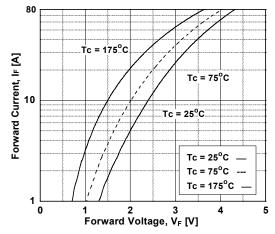


Figure 18. Turn off Switching SOA Characteristics











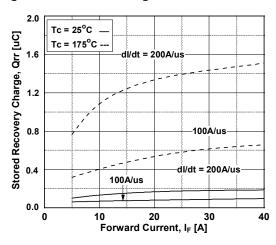
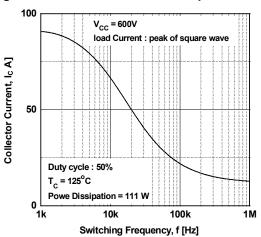
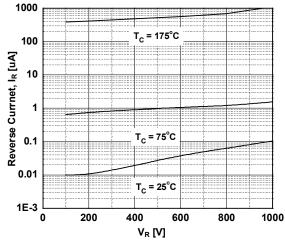


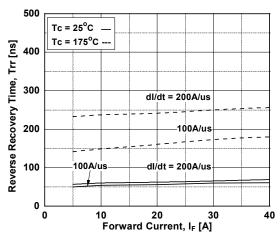
Figure 20. Load Current Vs. Frequence











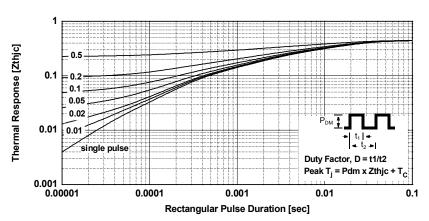
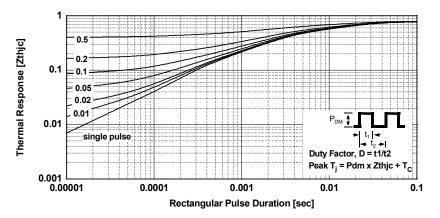


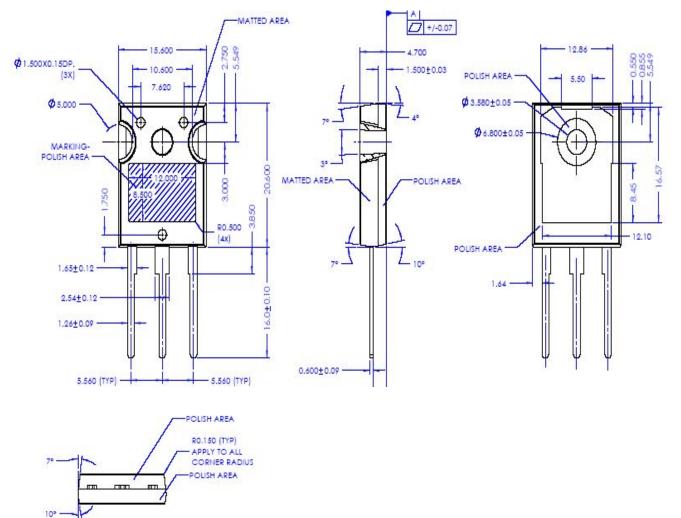
Figure 25. Transient Thermal Impedance of IGBT





Mechanical Dimensions

TO - 247AB (FKS PKG CODE 001)



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